SiB912DK

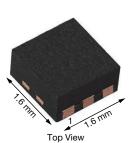
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Dual N-Channel 20 V MOSFET

PowerPAK[®] SC-75-6L Dual





Marking code: CA

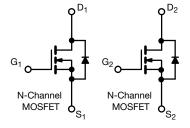
| PRODUCT SUMMARY | | | | | | | | | |
|--|-------|--|--|--|--|--|--|--|--|
| V _{DS} (V) | 20 | | | | | | | | |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V | 0.216 | | | | | | | | |
| $R_{DS(on)}$ max. (Ω) at V_GS = 2.5 V | 0.268 | | | | | | | | |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 1.8 V | 0.375 | | | | | | | | |
| Q _g typ. (nC) | 1.2 | | | | | | | | |
| I _D (A) ^{a, g} | 1.5 | | | | | | | | |
| Configuration | Dual | | | | | | | | |

FEATURES

- TrenchFET[®] power MOSFET
- Thermally enhanced PowerPAK[®] SC-75 package
 - Small footprint area
 - Low on-resistance
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Load switch, PA switch, and battery switch for portable devices
- DC/DC converter



| ORDERING INFORMATION | | | | | | |
|---------------------------------|-----------------|--|--|--|--|--|
| Package | PowerPAK SC-75 | | | | | |
| Lead (Pb)-free and halogen-free | SiB912DK-T1-GE3 | | | | | |

| ABSOLUTE MAXIMUM RATINGS | (T _A = 25 °C, unless | otherwise note | d) | | | | |
|---|---------------------------------|-----------------------------------|------------------------|------|--|--|--|
| PARAMETER | | SYMBOL LIMIT | | UNIT | | | |
| Drain-source voltage | | V _{DS} | 20 | V | | | |
| Gate-source voltage | | V _{GS} | V _{GS} ±8 | | | | |
| | T _C = 25 °C | | 1.5 ^a | | | | |
| Continuous drain surrent (T 150 °C) | T _C = 70 °C | | 1.5 ^a | | | | |
| Continuous drain current ($T_J = 150 \ ^\circ C$) | T _A = 25 °C | I _D | 1.5 ^{a, b, c} | | | | |
| | T _A = 70 °C | | 1.4 ^{b, c} | A | | | |
| Pulsed drain current | | I _{DM} | 5 | | | | |
| Ocationary company during diada company | T _C = 25 °C | 1 | 1.5 ^a | | | | |
| Continuous source-drain diode current | T _A = 25 °C | I _S | 0.9 ^{b, c} | | | | |
| | T _C = 25 °C | | 3.1 | | | | |
| Maximum namer dissinction | T _C = 70 °C | | 2 | w | | | |
| Maximum power dissipation | T _A = 25 °C | P _D | 1.1 ^{b, c} | vv | | | |
| | T _A = 70 °C | | 0.7 ^{b, c} | | | | |
| Operating junction and storage temperature rate | nge | T _J , T _{stg} | -55 to +150 | °C | | | |
| Soldering recommendations (peak temperature | e) d, e | | 260 | | | | |

| THERMAL RESISTANCE RATINGS | | | | | | | | | |
|---|--------------|-------------------|---------|---------|------|--|--|--|--|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | | | | |
| Maximum junction-to-ambient ^{b, f} | t ≤ 5 s | R _{thJA} | 90 | 115 | °C/W | | | | |
| Maximum junction-to-case (drain) | Steady state | R _{thJC} | 32 | 40 | | | | | |

Notes

a. Package limited b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components Maximum under steady state conditions is 125 °C/W

f.

g. Based on T_C = 25 °C

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Document Number: 68883

For technical questions, contact: pmostechsupport@vishay.com

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SiB912DK

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|-------------------------|--|------|-------|-------|-------|
| Static | | | | | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \ \mu\text{A}$ | 20 | - | - | V |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | L 050 A | - | 22 | - | |
| V _{GS(th)} temperature coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | - | -2 | - | mV/°C |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS}=V_{GS},\ I_D=250\ \mu A$ | 0.4 | - | 1 | V |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$ | - | - | ±100 | nA |
| Zere gete veltege drein eurrent | 1 | $V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | - | - | 1 | |
| Zero gate voltage drain current | IDSS | V_{DS} = 20 V, V_{GS} = 0 V, T_{J} = 55 °C | - | - | 10 | μA |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | 5 | - | - | А |
| | | $V_{GS} = 4.5 \text{ V}, I_D = 1.8 \text{ A}$ | - | 0.180 | 0.216 | |
| Drain-source on-state resistance ^a | R _{DS(on)} | $V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 1.6 \text{ A}$ | - | 0.223 | 0.268 | Ω |
| | | $V_{GS} = 1.8 \text{ V}, I_D = 0.3 \text{ A}$ | - | 0.300 | 0.375 | |
| Forward transconductance a | g fs | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1.8 \text{ A}$ | - | 3 | - | S |
| Dynamic ^b | | | | | | |
| Input capacitance | C _{iss} | | - | 95 | - | pF |
| Output capacitance | Coss | V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz | - | 24 | - | |
| Reverse transfer capacitance | C _{rss} | | - | 11 | - | |
| Total gata charge | 0 | $V_{DS} = 10 \text{ V}, V_{GS} = 8 \text{ V}, I_D = 1.8 \text{ A}$ | - | 2 | 3 | nC |
| Total gate charge | Qg | | - | 1.2 | 1.8 | |
| Gate-source charge | Q _{gs} | V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 1.8 A | - | 0.3 | - | |
| Gate-drain charge | Q _{gd} | | - | 0.15 | - | |
| Gate resistance | Rg | f = 1 MHz | 0.5 | 2.5 | 5 | Ω |
| Turn-on delay time | t _{d(on)} | | - | 5 | 10 | |
| Rise time | t _r | V_{DD} = 10 V, R_L = 7.1 Ω , | - | 10 | 20 | |
| Turn-off delay time | t _{d(off)} | $I_D \cong$ 1.4 A, V_{GEN} = 4.5 V, R_g = 1 Ω | - | 24 | 36 | |
| Fall time | t _f | | - | 8 | 16 | |
| Turn-on delay time | t _{d(on)} | | - | 2 | 4 | ns |
| Rise time | tr | V_{DD} = 10 V, R_L = 7.1 Ω , | - | 9 | 18 | |
| Turn-off delay time | t _{d(off)} | $I_D \cong$ 1.4 A, V_{GEN} = 8 V, R_g = 1 Ω | - | 8 | 16 | |
| Fall time | t _f | | - | 7 | 14 | |
| Drain-Source Body Diode Characterist | ics | | | | | |
| Continuous source-drain diode current ^c | I _S | T _C = 25 °C | - | - | 1.5 | ۸ |
| Pulse diode forward current | I _{SM} | | - | - | 5 | A |
| Body diode voltage | V _{SD} | $I_{S} = 1.4 \text{ A}, V_{GS} = 0 \text{ V}$ | - | 0.7 | 1.2 | V |
| Body diode reverse recovery time | t _{rr} | | - | 9 | 18 | ns |
| Body diode reverse recovery charge | Q _{rr} | I _F = 1.4 A, di/dt = 100 A/μs, | - | 3 | 6 | nC |
| Reverse recovery fall time | t _a | T _J = 25 °C | - | 6 | - | ns |
| | | | 1 | | | |

Notes

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Package limited

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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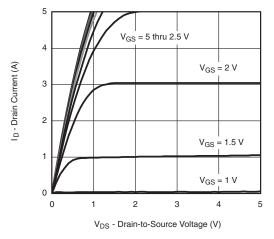
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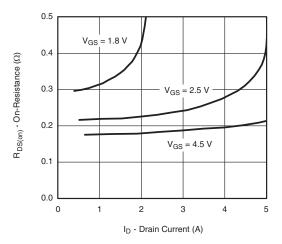
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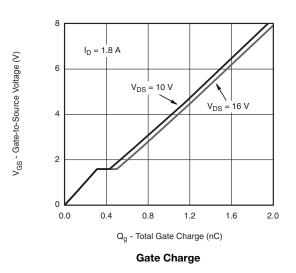
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

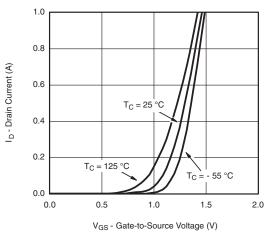


Output Characteristics

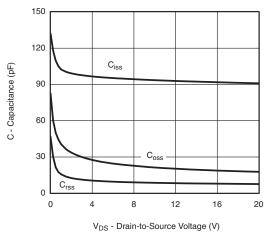


On-Resistance vs. Drain Current and Gate Voltage

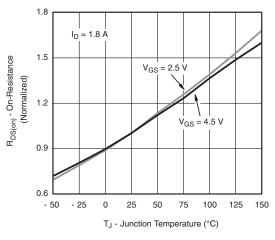




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

S-82022-Rev. A, 01-Sep-08

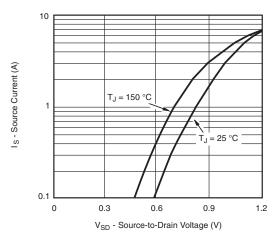
3

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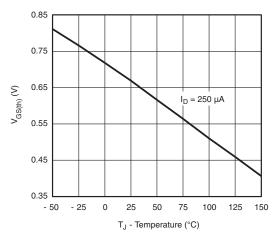
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



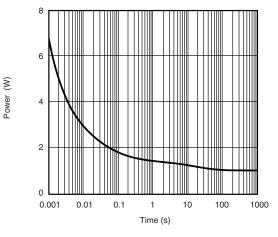
Source-Drain Diode Forward Voltage



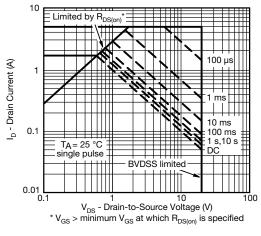


0.4 I_D = 1.8 A $R_{DS(on)}$ - On-Resistance (Ω) 0.3 T_J = 125 °C 0.2 T_J = 25 °C 0.1 0.0 0 2 4 6 8 V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



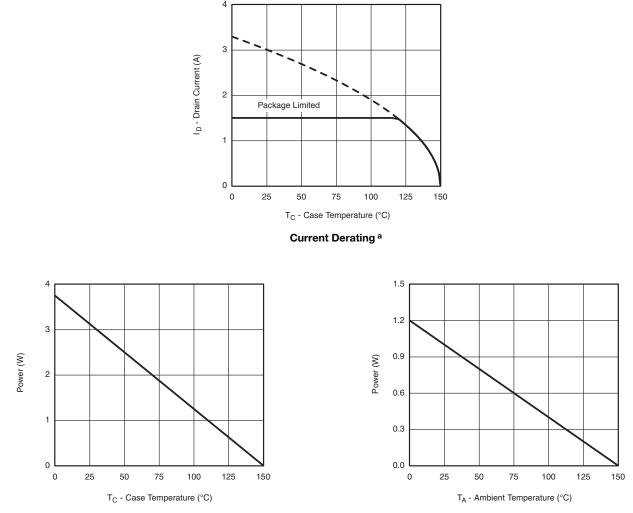
Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Case



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Power Derating, Junction-to-Case



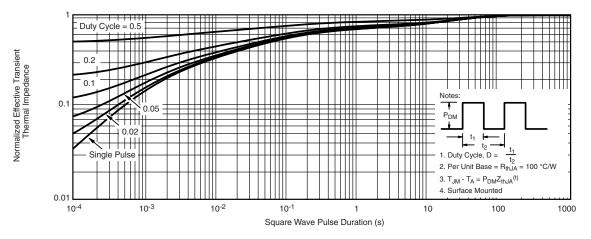
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

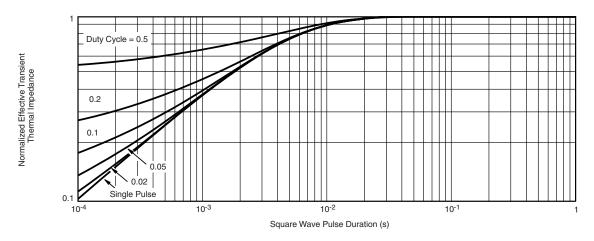
5



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

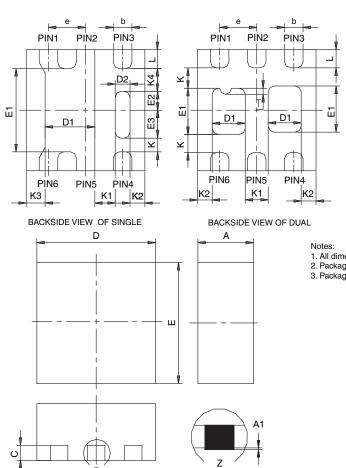
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Package Information

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PowerPAK[®] SC75-6L



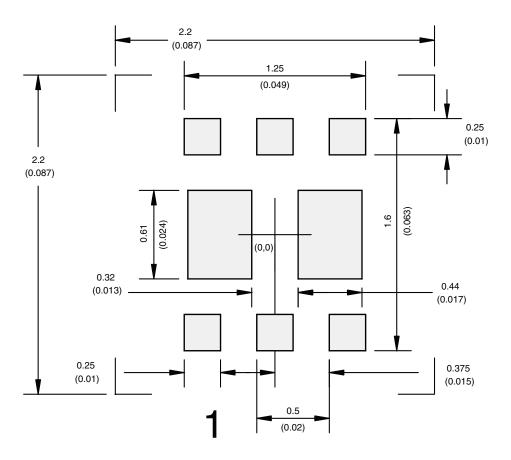
All dimensions are in millimeters
Package outline exclusive of mold flash and metal burr
Package outline inclusive of plating

DETAIL Z

| | SINGLE PAD | | | | | | DUAL PAD | | | | | | |
|---|------------|-----------|------|-----------|-----------|-------|-----------|-------------|------|-----------|-----------|-------|--|
| DIM | М | ILLIMETER | RS | | INCHES | | М | MILLIMETERS | | | INCHES | | |
| | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max | |
| Α | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 | |
| A1 | 0 | - | 0.05 | 0 | - | 0.002 | 0 | - | 0.05 | 0 | - | 0.002 | |
| b | 0.18 | 0.25 | 0.33 | 0.007 | 0.010 | 0.013 | 0.18 | 0.25 | 0.33 | 0.007 | 0.010 | 0.013 | |
| С | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | |
| D | 1.53 | 1.60 | 1.70 | 0.060 | 0.063 | 0.067 | 1.53 | 1.60 | 1.70 | 0.060 | 0.063 | 0.067 | |
| D1 | 0.57 | 0.67 | 0.77 | 0.022 | 0.026 | 0.030 | 0.34 | 0.44 | 0.54 | 0.013 | 0.017 | 0.021 | |
| D2 | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 | | | | | | | |
| E | 1.53 | 1.60 | 1.70 | 0.060 | 0.063 | 0.067 | 1.53 | 1.60 | 1.70 | 0.060 | 0.063 | 0.067 | |
| E1 | 1.00 | 1.10 | 1.20 | 0.039 | 0.043 | 0.047 | 0.51 | 0.61 | 0.71 | 0.020 | 0.024 | 0.028 | |
| E2 | 0.20 | 0.25 | 0.30 | 0.008 | 0.010 | 0.012 | | | | | | | |
| E3 | 0.32 | 0.37 | 0.42 | 0.013 | 0.015 | 0.017 | | | | | | | |
| е | | 0.50 BSC | | | 0.020 BSC | | | 0.50 BSC | | | 0.020 BSC | | |
| K | | 0.180 TYP | | | 0.007 TYP | | 0.245 TYP | | | 0.010 TYP | | | |
| K1 | | 0.275 TYP | | | 0.011 TYP | | 0.320 TYP | | | 0.013 TYP | | | |
| K2 | | 0.200 TYP | | | 0.008 TYP | | 0.200 BSC | | | 0.008 TYP | | | |
| K3 | | 0.255 TYP | | 0.010 TYP | | | | | | | | | |
| K4 | | 0.300 TYP | | 0.012 TYP | | | | | | | | | |
| L | 0.15 | 0.25 | 0.35 | 0.006 | 0.010 | 0.014 | 0.15 | 0.25 | 0.35 | 0.006 | 0.010 | 0.014 | |
| Т | | | | | | | 0.03 | 0.08 | 0.13 | 0.001 | 0.003 | 0.005 | |
| ECN: C-07431 – Rev. C, 06-Aug-07 DWG: 5935 | | | | | | | | | | | | | |



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC75-6L Dual



Dimensions in mm/(Inches)

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